

NPN High Voltage Power Silicon Transistor

Rev. V1

Features

- Available in JAN, JANTX, JANTXV, JANS and JANSR per MIL-PRF-19500/455
- 2N5664 and 2N5665 available in TO-66 package
- 2N5666 and 2N5667 are available in both TO-5 and TO-39 packages
- 2N5666 is available in the surface mount U3 version



Electrical Characteristics (T_A = +25°C unless otherwise specified)

Parameter	Test Conditions	Symbol	Units	Min.	Max.
Breakdown Voltage Collector - Emitter	I_C = 10 mA dc, R_1 = 100 Ω 2N5664, 2N5666, 2N5666S 2N5665, 2N5667, 2N5667S	V _{(BR)CER}	V dc	250 400	_
Breakdown Voltage Emitter - Base	I _E = 10 mA dc	V _{(BR)EBO}	V dc	6	_
Collector - Emitter Cutoff Current	V _{CE} = 200 V dc 2N5664, 2N5666, 2N5666S V _{CE} = 300 V dc 2N5665, 2N5667, 2N5667S	I _{CES1}	μA dc	_	0.2
Collector - Base Cutoff Current	V _{CB} = 200 Vdc 2N5664, 2N5666, 2N5666S V _{CB} = 250 Vdc 2N5664, 2N5666, 2N5666S V _{CB} = 300 V dc 2N5665, 2N5667, 2N5667S V _{CB} = 400 V dc 2N5665, 2N5667, 2N5667S	І _{СВО}	μA dc mA dc μA dc mA dc	_	0.1 1.0 0.1 1.0
Forward - Current Transfer Ratio	V _{CE} = 2 V dc, I _C = 0.5 A dc 2N5664, 2N5666, 2N5666S 2N5665, 2N5667, 2N5667S	h _{FE1}		40 25	
Forward - Current Transfer Ratio	V _{CE} = 5 V dc, I _C = 1.0 A dc 2N5664, 2N5666, 2N5666S 2N5665, 2N5667, 2N5667S	h _{FE2}		40 25	120 75
Forward - Current Transfer Ratio	V _{CE} = 5 V dc, I _C = 3.0 A dc 2N5664, 2N5666, 2N5666S 2N5665, 2N5667, 2N5667S	h _{FE3}		15 10	
Forward - Current Transfer Ratio	$V_{CE} = 5 \text{ V dc}, I_{C} = 5.0 \text{ A dc}$	h _{FE4}		5	
Collector - Emitter Saturation Voltage	I _C = 3.0 A dc I _B = 0.3 A dc 2N5664, 2N5666, 2N5666S I _B = 0.6 A dc 2N5665, 2N5667, 2N5667S	V _{CE(sat)1}	V dc		0.4
Collector - Emitter Saturation Voltage	$I_C = 5.0 \text{ A dc}, I_B = 1 \text{ A dc}$	V _{CE(sat)2}	V dc		1.0



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Parameter	Test Conditions	Symbol	Units	Min.	Max.
Base - Emitter Saturation Voltage	$I_{C} = 3.0 \text{ A dc}$ $I_{B} = 0.3 \text{ A dc } 2\text{N}5664, 2\text{N}5666, 2\text{N}5666S}$ $I_{B} = 0.6 \text{ A dc } 2\text{N}5665, 21\text{N}5667, 2\text{N}5667S}$		V dc		1.2
Base - Emitter Saturation Voltage	I _C = 5.0 A dc, I _B = 1 A dc V		V dc		1.5
Collector - Emitter Cutoff Current	T _A = 150°C V _{CE} = 200 V dc 2N5664, 2N5666, 2N5666S V _{CE} = 300 V dc 2N5665, 2N5667, 2N5667S	I _{CES2}	μA dc	_	100
Forward - Current Transfer Ratio	T _A = -55°C V _{CE} = 5 V dc, I _C = 1.0 A dc 2N5664, 2N5666, 2N5666S 2N5665, 2N5667, 2N5667S	h _{FE5}		15 10	
Dynamic Characteristics					
Magnitude of Common-Emitter Small - Signal Short - Circuit Forward -Current Transfer Ratio	$V_{CE} = 5 \text{ V dc}, I_{C} = 0.5 \text{ A dc}, f = 10 \text{ MHz}$	h _{FE}		2.0	7.0
Open-Circuit Output Capacitance	V _{CB} = 10 V dc, 100 kHz ≤ f ≤ 1 MHz	C _{obo}	pF	_	120
Pulse Response					
Turn-On Time	V _{CC} = 100V dc, I _C = 1.0 A dc, 2N5664, 2N5666, 2N5666S 2N5665, 2N5667, 2N5667S	t _{on}	μs	_	0.25
Turn-Off Time	V _{CC} = 100V dc, I _C = 1.0 A dc, 2N5664, 2N5666, 2N5666S 2N5665, 2N5667, 2N5667S	t _{off}	μs	_	1.5 2.0



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Absolute Maximum Ratings (T_A = +25°C unless otherwise specified)

Ratings	Symbol	Max. Value	
Collector-Base Voltage	V _{CBO}	2N5664, 2N5666, S; 2N5666U3 250 V dc 2N5665, 2N5667, S 400 V dc	
Collector-Emitter Voltage	V _{CEO}	2N5664, 2N5666, S; 2N5666U3 200 V dc 2N5665, 2N5667, S 300 V dc	
Emitter-Base Voltage	V _{EBO}	6 V dc	
Collector Current	I _C	5 A dc	
Base Current	I _B	1 A dc	
Junction and Storage Temperature	T _{stg} + T _J	-65°C to + 200°C	

Thermal Characteristics	Symbol	Max. Value
Thermal Resistance, Junction to Ambient 2N5664 2N5665 2N5666, 2N5666S 2N5666U3 2N5667, 2N5667S	R _{θJA} ⁽²⁾	70°C/W 70°C/W 145°C/W 116°C/W 145°C/W
Thermal Resistance, Junction to Case 2N5664 2N5665 2N5666, 2N5666S 2N5666U3 2N5667, 2N5667S	R _{eJC} (2)	2.6°C/W 2.6°C/W 6.7°C/W 2.3°C/W 6.7°C/W

⁽²⁾ For thermal impedance see figures 12, 13, 14 and 15 of MIL-PRF-19500/455 $\,$



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Absolute Maximum Ratings (T_A = +25°C unless otherwise specified)

Characteristics	Symbol	Max. Value
T _A = +25°C 2N5664 2N5665 2N5666, 2N5666L 2N5666U3 2N5667, 2N5667S	P _T ⁽¹⁾	2.5 W 2.5 W 1.2 W 1.5 W 1.2 W
T _C = +100°C 2N5664 2N5665 2N5666, 2N5666L 2N5666U3 2N5667, 2N5667S	P _T ⁽²⁾	30 W 30 W 15 W 35 W 15 W

⁽¹⁾ For derating see figures 7, 8, 9, 10 and 11 of MIL-PRF-19500/455

Safe Operating Area			
DC Tests:	$T_C = +100$ °C; I Cycle; $t \ge 1.0$ s; t_r	+ t _f = 10 μs	
Test 1:	V_{CE} = 6 V dc; I_C = 5 A dc	2N5664, 2N5665	
Test 2:	V_{CE} = 32 V dc; I_{C} = 0.75 A dc V_{CE} = 40 V dc; I_{C} = 0.75 A dc	2N5664 2N5665	
Test 3:	V_{CE} = 200 V dc; I_{C} = 29 mA dc V_{CE} = 300 V dc; I_{C} = 21 mA dc	2N5664 2N5665	
DC Tests:	$T_C = +100^{\circ}C$; I Cycle; $t \ge 1.0s$; $t_r + t_f = 10 \ \mu s$		
Test 1:	V_{CE} = 3.0 V dc; I_C = 5 A dc	2N5666, 2N5666S, 2N5667, 2N5667S	
Test 2:	V_{CE} = 29 V dc; I_{C} = 0.4 A dc V_{CE} = 37.5 V dc; I_{C} = 0.4 A dc	2N5666, 2N5666S 2N5667, 2N5667S	
Test 3:	V_{CE} = 200 V dc; I_{C} = 19 mA dc V_{CE} = 300 V dc; I_{C} = 14 mA dc	2N5666, 2N5666S 2N5667, 2N5667S	

Safe Operating Area (Switching)

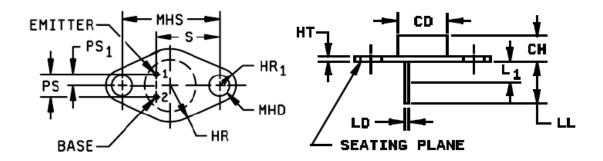
Load condition B (clamped inductive load). T_C = + 100°C, t_r + $t_f \le 10$ µs, duty cycle ≤ 2 percent; t_p = 4 ms; R_S = 0.5 Ω , R_{BB1} = 50 Ω , V_{BB1} = 50 V dc, R_{BB2} = 50 Ω , V_{BB2} = -4 V dc, I_C = 5 A dc, V_{CC} = 50 V dc, $R_L \le 2.5$ Ω , L = 40 mH (Triad C-48U or equivalent)

Clamp voltage = 200 +0, -5 V dc 2N5664, 2N5666, 2N5666S Clamp voltage = 300 +0, -5 V dc 2N5665, 2N5667, 2N5667S



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Outline Drawing (TO-66)



		Dimensions				
Ltr	Inches		Milli	Notes		
	Min	Max	Min	Max		
CH	.250	.340	6.35	8.64		
LD	.028	.034	0.71	0.86	7,9	
CD	.470	.500	11.94	12.70	2	
PS	.190	.210	4.83	5.33	3	
PS ₁	.093	.107	2.36	2.72	3	
HT	.050	.075	1.27	1.91	2, 5	
LL	.360	.500	9.14	12.70	7	
L ₁		.050		1.27	4	
MHD	.142	.152	3.61	3.86		
MHS	.958	.962	24.33	24.43		
HR		.350		8.89		
HR ₁	.115	.145	2.92	3.68		
S	.570	.590	14.48	14.99	3	

NOTES:

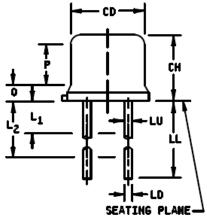
- 1. Dimensions are in inches. Millimeters are given for general information only.
- 2. Body contour is optional within zone defined by CD.
- These dimensions shall be measured at points .050 inch (1.27 mm) to .055 inch (1.40 mm) below seating plane. When gauge is not used, measurement shall be made at seating plane.
- 4. Within this zone the lead diameter may vary to allow for lead finishes and irregularities.
- HT dimension does not include sealing flanges.
- The seating plane of header shall be flat within .001 inch (0.025 mm), concave to .004 inch (0.101 mm), convex inside a .520 inch (13.20 mm) diameter circle on the center of the header, and flat within .001 inch (0.025 mm), concave to .006 inch (0.152 mm), convex overall.
- Both terminals.
- 8. The collector shall be electrically connected to the case.
- LD applies between L₁ and LL. Lead diameter shall not exceed twice LD within L₁.
- Pin 1 is the emitter, pin 2 is the base.
- In accordance with ASME Y14.5M, diameters are equivalent to φx symbology.

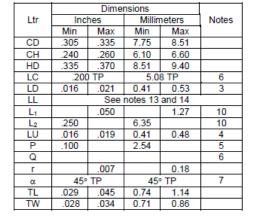
FIGURE 1. Physical dimensions of transistor types 2N5664 and 2N5665 (TO-66).

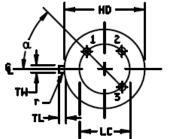


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Outline Drawing (TO-5, TO-39)







NOTES:

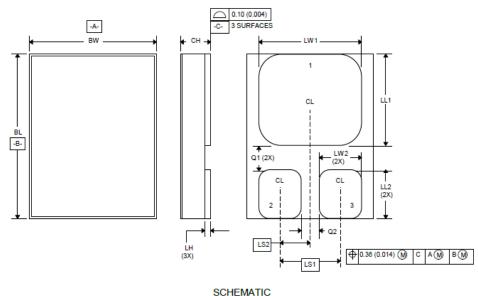
- 1. Dimensions are in inches.
- Millimeters are given for general information only.
- 3. Measured in the zone beyond .250 inch (6.35 mm) from the seating plane.
- 4. Measured in the zone .050 inch (1.27 mm) and .250 inch (6.35 mm) from the seating plane.
- 5. Variations on dimension CD in this zone shall not exceed .010 inch (0.25 mm).
- 6. Outline in this zone is not controlled.
- 7. When measured in a gauging plane .054 inch +.001, -.000 (1.37 mm +.03, -.00) below the seating plane of the transistor, maximum diameter leads shall be within .007 inch (.18 mm) of their true location relative to a maximum width tab. Smaller diameter leads shall fall within the outline of the maximum diameter lead tolerance.
- 8. The collector shall be electrically connected to the case.
- Measured from the maximum diameter of the actual device.
- All three leads
- Diameter of leads in this zone is not controlled.
- 12. Lead 1 emitter; lead 2 base, lead 3 collector.
- For transistor types 2N5666 and 2N5667, LL is 1.500 inch (38.1 mm) minimum and 1.75 inch (44.45 mm) maximum.
- For transistor types 2N5666S and 2N5667S, LL is .500 inch (12.7 mm) minimum and .75 inch (19.05 mm) maximum.
- 15. In accordance with ASME Y14.5M, diameters are equivalent to φx symbology.

FIGURE 2. Physical dimensions of transistor types 2N5666, 2N5666S, 2N5667 and 2N5667S (TO-5 and TO-39).



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Outline Drawing (U3 Package)





Ltr	Dimensions				
	Inches		Millimeters		
	Min	Max	Min	Max	
BL	.395	.405	10.04	10.28	
BW	.291	.301	7.40	7.64	
CH	.1085	.1205	2.76	3.06	
LH	.010	.020	0.25	0.51	
LW1	.281	.291	7.14	7.39	
LW2	.090	.100	2.29	2.54	
LL1	.220	.230	5.59	5.84	
LL2	.115	.125	2.93	3.17	
LS1	.150 BSC		3.81 BSC		
LS2	.075 BSC		1.91 BSC		
Q1	.030		0.762		
Q2	.030		0.762		

NOTES:

- 1. Dimensions are in inches.
- 2. Millimeters are given for general information only.
- 3. In accordance with ASME Y14.5M, diameters are equivalent to φx symbology.
- Terminal 1 collector, terminal 2 base, terminal 3 emitter.

FIGURE 3. Physical dimensions, surface mount (2N5666U3 version).



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